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PATENTS ONLY

Attorney Docket Number 061094-5011

05-11-2005

Mail



103000426

Please record the attached original documents or copy thereof.

1. Name(s) of conveying party(ies): Florida RF Labs, Inc. Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	2. Name and address of receiving party(ies): Name: Smiths Interconnect Microwave Components, Inc. Address: 8851 SW Old Kansas Avenue Stuart, FL 34997 Country (if other than USA):
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment Merger <input type="checkbox"/> Security Agreement Change of Name <input type="checkbox"/> Other Execution Date: April 26, 2005	

4. Application number(s) or patent number(s): 09/325,360; 09/394,721; 10/458,074; 10/912,726; 10/912,731

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)	B. Patent No.(s)
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Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed: Customer No. 009629 Morgan, Lewis & Bockius LLP 1111 Pennsylvania Avenue, NW Washington, DC 20004	6. Number of applications and patents involved: 5	
	7. Total fee (37 CFR 3.41):.....\$ 200.00 <input checked="" type="checkbox"/> Please charge to the deposit account listed in Section 8.	
	8. Deposit account number: 50-0310 (Attach duplicate copy of this page if paying by deposit account)	

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Francis E. Morris	24,615		May 3, 2005
Name of Person Signing	Reg. No.	Signature	Date

Total number of pages including cover sheet, attachments, documents, and duplicate cover sheet for Deposit Account: **4**

Mail documents to be recorded with required cover sheet information to address above

05/11/2005 6TON11 00000009 500310 09325360
01 FC:8021 200.00 DA

ASSIGNMENT OF INTELLECTUAL PROPERTY

This Assignment is made on this 20th day of April, 2005 by and between Florida RF Labs, Inc., having a place of business at 8851 Southwest Old Kansas Ave., Stuart, FL 34997, ("Assignor"), and Smiths Interconnect Microwave Components, Inc., having a place of business at 8851 SW Old Kansas Avenue, Stuart, FL 34997 ("Assignee").

WHEREAS, Assignor wishes to assign Intellectual Property identified on the attached Schedule to Assignee, and Assignee wishes to accept the assignment of such Intellectual Property.

NOW THEREFORE, for good and valuable consideration the receipt of which is hereby acknowledged, Assignor hereby sells, assigns, transfers, and sets over unto the Assignee, its lawful successors and assigns, effective as of the date hereof, all right, title, and interest in and to the Intellectual Property, and all division, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment, including the right to seek and obtain for Assignees' own benefit injunctive relief and recovery of damages for any past and/or future infringements, including enhanced damages and/or attorney's fees for willful infringement. Assignor covenants with Assignee, its successors and assigns, that the rights, title and interest in and to the Intellectual Property herein conveyed are free and clear of any encumbrance, that no assignment, sale, or agreement has been or will be made or entered into which would conflict with this Assignment and that Assignor has the full right to convey the same as herein expressed.

IN WITNESS WHEREOF, Assignor has caused this Intellectual Property Assignment to be executed as set forth below.

ASSIGNOR:

By: 

Name: ALEN FETZULI

Title: VP OF ENGINEERING

**Schedule of Assignments by and between Florida RF Labs, Inc. and Smiths Interconnect
Microwave Components, Inc.**

U.S. Application Number	Filing Date	First-Named Inventor	Title
09/325,360	Jun. 4, 1999	Ferguson	TEMPERATURE SENSING TERMINATION
09/394,721	Sep. 13, 1999	Ferguson et al.	TUNED REACTANCE CAVITY ELECTRICAL TERMINATION
10/458,074	Jun. 10, 2003	Cliff, et al.	INTEGRATED N-WAY WILKINSON POWER DIVIDER/COMBINER
10/912,726	Aug. 5, 2004	Robert Blacka	WIDEBAND TEMPERATURE- VARIABLE ATTENUATOR
10/912,731	Aug. 5, 2004	Blacka, et al.	HIGH-FREQUENCY TEMPERATURE-VARIABLE ATTENUATOR